

10/564236

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

1020 Recd PTO 10 JAN 2006

Appl. No. : Unassigned Confirmation No. Unassigned  
First Inventor : SOLO DE ZALDIVAR Jose  
Filed : Concurrently  
TC/A.U. : Unassigned  
Examiner : Unassigned

Docket No. : DE03 0254 US1  
Customer No. : 24738

Title: Metal Bump with an Insulation for the Side Walls and Method  
of Fabricating a Chip with such a Metal Bump

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT**

Sir:

Prior to calculation of the filing fee and examination please amend the above-  
identified application as follows:

**Amendments to the Specification** there are no amendments in this paper.

**Amendments to the Claims** begin on page 2 of this paper.

**Remarks/Arguments** begin on page 4 of this paper.